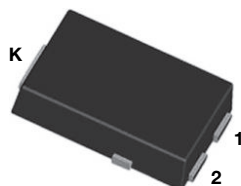


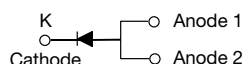
# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.32 \text{ V}$  at  $I_F = 5 \text{ A}$

## eSMP® Series



SMPC (TO-277A)



## LINKS TO ADDITIONAL RESOURCES



3D Models

## PRIMARY CHARACTERISTICS

|                                                             |                |
|-------------------------------------------------------------|----------------|
| $I_{F(AV)}$                                                 | 15 A           |
| $V_{RRM}$                                                   | 60 V           |
| $I_{FSM}$                                                   | 220 A          |
| $V_F$ at $I_F = 15 \text{ A}$ ( $T_J = 125^\circ\text{C}$ ) | 0.48 V         |
| $T_J$ max.                                                  | 150 °C         |
| Package                                                     | SMPC (TO-277A) |
| Circuit configuration                                       | Single         |

## FEATURES

- Very low profile - typical height of 1.1 mm
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

## MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| PARAMETER                                                                          | SYMBOL            | V15PL63     | UNIT |
|------------------------------------------------------------------------------------|-------------------|-------------|------|
| Device marking code                                                                |                   | 15L63       |      |
| Maximum repetitive peak reverse voltage                                            | $V_{RRM}$         | 60          | V    |
| Maximum average forward rectified current (fig. 1)                                 | $I_{F(AV)}^{(1)}$ | 15          | A    |
|                                                                                    | $I_{F(AV)}^{(2)}$ | 4.8         |      |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$         | 220         | A    |
| Operating junction temperature range                                               | $T_J^{(3)}$       | -40 to +150 | °C   |
| Storage temperature range                                                          | $T_{STG}$         | -55 to +150 | °C   |

## Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) |                      |                                     |             |      |      |
|-----------------------------------------------------------------------------------------|----------------------|-------------------------------------|-------------|------|------|
| PARAMETER                                                                               | TEST CONDITIONS      | SYMBOL                              | TYP.        | MAX. | UNIT |
| Instantaneous forward voltage                                                           | $I_F = 5.0\text{ A}$ | $V_F^{(1)}$                         | 0.43        | -    | V    |
|                                                                                         | $I_F = 7.5\text{ A}$ |                                     | 0.45        | -    |      |
|                                                                                         | $I_F = 15\text{ A}$  |                                     | 0.52        | 0.58 |      |
|                                                                                         | $I_F = 5.0\text{ A}$ |                                     | 0.32        | -    |      |
|                                                                                         | $I_F = 7.5\text{ A}$ |                                     | 0.36        | -    |      |
|                                                                                         | $I_F = 15\text{ A}$  |                                     | 0.48        | 0.55 |      |
| Reverse current                                                                         | $V_R = 60\text{ V}$  | $T_J = 25\text{ }^{\circ}\text{C}$  | $I_R^{(2)}$ | -    | mA   |
|                                                                                         |                      | $T_J = 125\text{ }^{\circ}\text{C}$ | 16          | 35   |      |
| Typical junction capacitance                                                            | 4.0 V, 1 MHz         | $C_J$                               | 3000        | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ 

| THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) |                          |         |                      |
|--------------------------------------------------------------------------------------|--------------------------|---------|----------------------|
| PARAMETER                                                                            | SYMBOL                   | V15PL63 | UNIT                 |
| Typical thermal resistance                                                           | $R_{\theta JA}^{(1)(2)}$ | 75      | $^{\circ}\text{C/W}$ |
|                                                                                      | $R_{\theta JM}^{(3)}$    | 4       |                      |

**Notes**(1) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (2) Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| V15PL63-M3/H                   | 0.10            | H                      | 1500          | 7" diameter plastic tape and reel  |
| V15PL63-M3/I                   | 0.10            | I                      | 6500          | 13" diameter plastic tape and reel |
| V15PL63HM3/H <sup>(1)</sup>    | 0.10            | H                      | 1500          | 7" diameter plastic tape and reel  |
| V15PL63HM3/I <sup>(1)</sup>    | 0.10            | I                      | 6500          | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

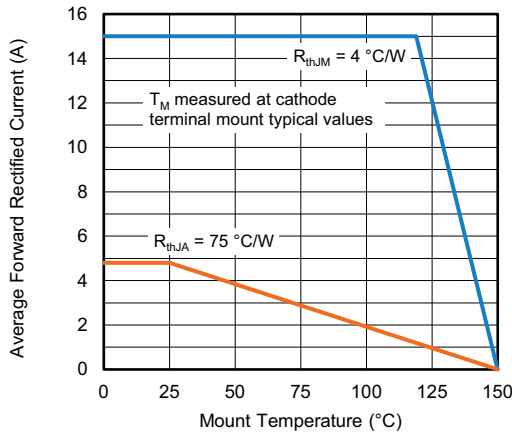
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Forward Current Derating Curve

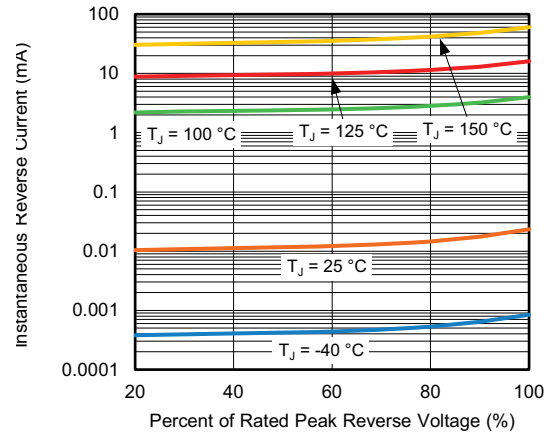


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

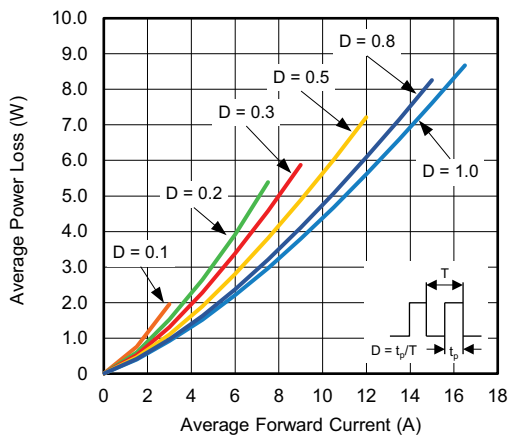


Fig. 2 - Forward Power Loss Characteristics

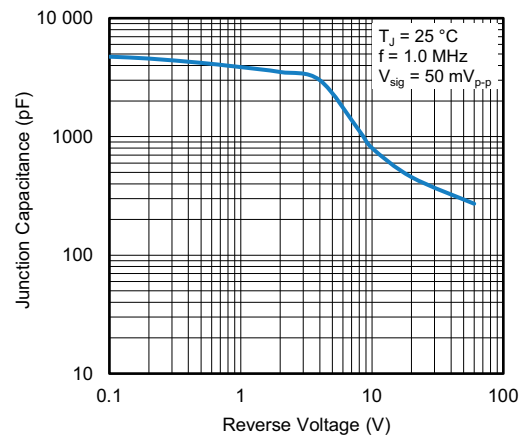


Fig. 5 - Typical Junction Capacitance

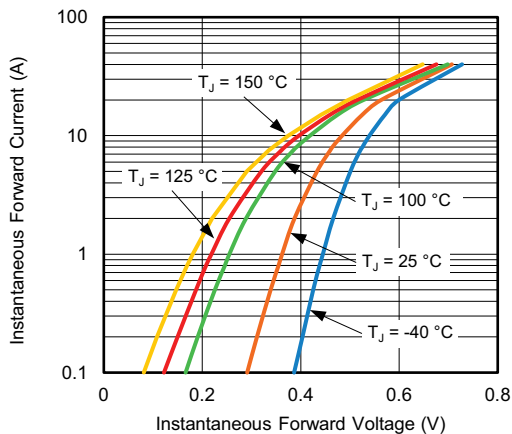


Fig. 3 - Typical Instantaneous Forward Characteristics

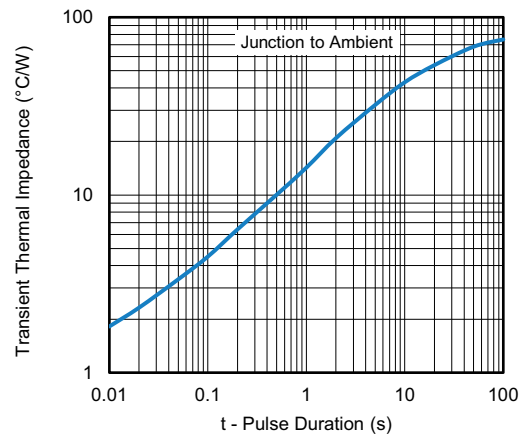
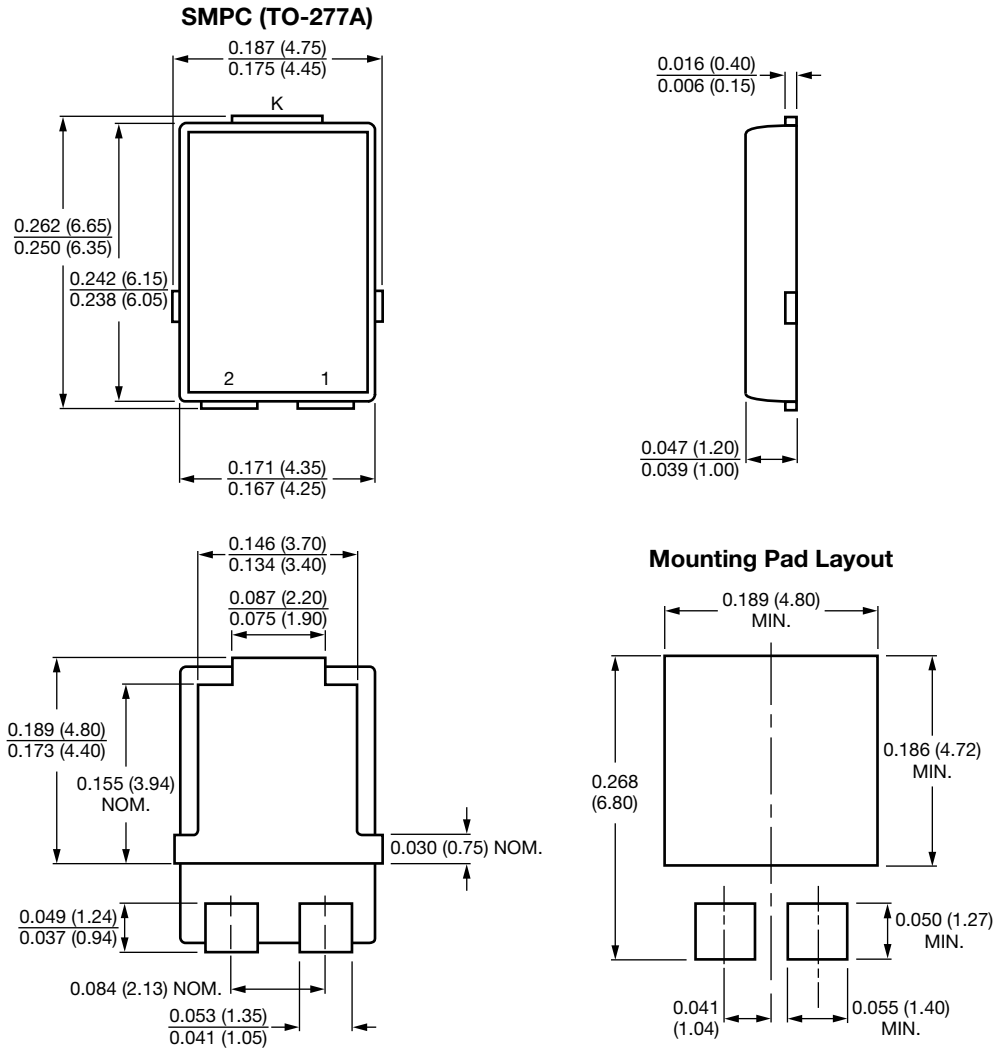


Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)




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